## FLASH MEMORY

## 64M (4M × 16) BIT

## MBM29LV652UE -90/12

## ■ GENERAL DESCRIPTION

The MBM29LV652UE is a 64M-bit, 3.0 V-only Flash memory organized as 4M words of 16 bits each. The device is designed to MBM29LV652UEbe programmed in system with the standard system 3.0 V Vcc supply. 12.0 V VPP and 5.0 V Vcc are not required for write or erase operations. The devices can also be reprogrammed in standard EPROM programmers.
To eliminate bus contention the devices have separate chip enable ( $\overline{\mathrm{CE}}$ ), write enable ( $\overline{\mathrm{WE}}$ ), and output enable ( OE ) controls.
The MBM29LV652UE is entirely command set compatible with JEDEC single-power-supply Flash standard. Commands are written to the command register using standard microprocessor write timings. Register contents serve as input to an internal state-machine which controls the erase and programming circuitry. Write cycles also internally latch addresses and data needed for the programming and erase operations.
Typically, each sector can be programmed and verified in about 0.5 seconds.
■ PRODUCT LINE UP

| Part No. |  | MBM29LV652UE |  |
| :--- | :--- | :---: | :---: |
| Ordering Part No. | $\mathrm{V}_{\mathrm{cc}}=3.3 \mathrm{~V}_{-0.3 \mathrm{~V}}^{+0.3 \mathrm{~V}}$ | 90 | - |
|  | $\mathrm{V}_{\mathrm{cc}}=3.0 \mathrm{~V}_{-0.3 \mathrm{~V}}^{+0.6}$ | - | 12 |
|  | 90 | 120 |  |
| Max. $\overline{\mathrm{CE}}$ Access Time (ns) | 90 | 120 |  |
| Max. $\overline{\mathrm{OE}}$ Access Time (ns) | 35 | 50 |  |

PACKAGES


BGA-63P-M02

## MBM29LV652UE-90/12

(Continued)
A sector is typically erased and verified in 1.0 second. (If already completely preprogrammed.)
The device also features a sector erase architecture. The sector mode allows each sector to be erased and reprogrammed without affecting other sectors. The MBM29LV652UE is erased when shipped from the factory. Internally generated and regulated voltages are provided for the program and erase operations. A low Vcc detector automatically inhibits write operations on the loss of power. The end of program or erase is detected by Data Polling of DQ7, by the Toggle Bit feature on DQ6. Once the end of a program or erase cycle has been completed, the devices internally reset to the read mode.
The devices electrically erase all bits within a sector simultaneously via Fowler-Nordhiem tunneling. The words are programmed one word at a time using the EPROM programming mechanism of hot electron injection.

## FEATURES

- $0.23 \mu \mathrm{~m}$ Process Technology
- Single 3.0 V read, program and erase

Minimizes system level power requirements

- Compatible with JEDEC-standards

Uses same software commands with single-power supply Flash

- Address don't care during the command sequence
- Industry-standard pinouts

63-ball FBGA (Package suffix: PBT)

- Minimum 100,000 program/erase cycles
- High performance

90 ns maximum access time

- Flexible sector architecture

One hundred twenty-eight 32K word sectors
Any combination of sectors can be concurrently erased. Also supports full chip erase

- Hidden ROM (Hi-ROM) region

128 word of Hi-ROM, accessible through a new "Hi-ROM Enable" command sequence
Factory serialized and protected to provide a secure electronic serial number (ESN)

- Ready/Busy Output (RY/BY)

Hardware method for detection of program or erase cycle completion

- ACC input pin

At $V_{\text {Acc, }}$ increases program performance

- Embedded Erase ${ }^{\mathrm{TM} *}$ Algorithms

Automatically pre-programs and erases the chip or any sector

- Embedded program ${ }^{\text {TM* }}$ Algorithms

Automatically writes and verifies data at specified address

- Data Polling and Toggle Bit feature for detection of program or erase cycle completion
- Automatic sleep mode

When addresses remain stable, automatically switches themselves to low power mode

- Low Vcc write inhibit $\leq 2.5 \mathrm{~V}$
- Erase Suspend/Resume

Suspends the erase operation to allow a read data and/or program in another sector within the same device

- Sector group protection

Hardware method disables any combination of sector groups from program or erase operations

- Sector Group Protection Set function by Extended sector protect command
- Fast Programming Function by Extended Command


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(Continued)

- Temporary sector group unprotection

Temporary sector group unprotection via the RESET pin
This feature allows code changes in previously locked sectors

- In accordance with CFI (Common Flash Memory Interface)
*: Embedded Erase ${ }^{T M}$ and Embedded Program ${ }^{\text {TM }}$ are trademarks of Advanced Micro Devices, Inc.


## MBM29LV652UE-90/12

## PIN ASSIGNMENT

FBGA
(TOP VIEW)
Marking Side


BGA-63P-M02

[^0]- PIN DESCRIPTION

Table1 MBM29LV652UE Pin Configuration

| Pin | Function |
| :---: | :--- |
| $\mathrm{A}_{0}$ to $\mathrm{A}_{21}$ | Address Inputs |
| $\mathrm{DQ}_{0}$ to $\mathrm{DQ}_{15}$ | Data Inputs/Outputs |
| $\overline{\mathrm{CE}}$ | Chip Enable |
| $\overline{\mathrm{OE}}$ | Output Enable |
| $\overline{\mathrm{WE}}$ | Write Enable |
| RY/BY | Ready/Busy Output |
| $\overline{\mathrm{RESET}}$ | Hardware Reset Pin/Temporary Sector <br> Group Unprotection |
| ACC | Program Acceleration |
| Vccq | Output Buffer Power |
| N.C. | No Internal Connection |
| Vss | Device Ground |
| Vcc | Device Power Supply |

## MBM29LV652UE-90/12

## BLOCK DIAGRAM



■ LOGIC SYMBOL


## MBM29LV652UE-90/12

## $\square$ DEVICE BUS OPERATION

Table2 MBM29LV652UE User Bus Operations

| Operation | $\overline{C E}$ | $\overline{O E}$ | $\overline{W E}$ | $\mathrm{A}_{0}$ | $\mathrm{A}_{1}$ | A6 | A9 | DQ ${ }_{0}$ to $\mathrm{DQ}_{15}$ | RESET |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Auto-Select Manufacture Code *1 | L | L | H | L | L | L | VID | Code | H |
| Auto-Select Device Code *1 | L | L | H | H | L | L | VID | Code | H |
| Read *3 | L | L | H | A0 | $\mathrm{A}_{1}$ | $\mathrm{A}_{6}$ | A9 | Dout | H |
| Standby | H | X | X | X | X | X | X | HIGH-Z | H |
| Output Disable | L | H | H | X | X | X | X | HIGH-Z | H |
| Write (Program/Erase) | L | H | L | $\mathrm{A}_{0}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{6}$ | $\mathrm{A}_{9}$ | Din | H |
| Enable Sector Group Protection *2 *4 | L | VID | บ | L | H | L | VID | X | H |
| Verify Sector Group Protection *2 *4 | L | L | H | L | H | L | VID | Code | H |
| Temporary Sector Group Unprotection *5 | X | X | X | X | X | X | X | X | VID |
| Reset (Hardware)/Standby | X | X | X | X | X | X | X | HIGH-Z | L |

Legend: $\mathrm{L}=\mathrm{V}_{\mathrm{IL}}, \mathrm{H}=\mathrm{V}_{\mathrm{H}}, \mathrm{X}=\mathrm{V}_{\mathrm{IL}}$ or $\mathrm{V}_{\mathrm{H}}$. $\checkmark=$ Pulse input. See DC Characteristics for voltage levels.
*1: Manufacturer and device codes may also be accessed via a command register write sequence. See Table 3.
*2: Refer to the section on Sector Group Protection.
*3: $\overline{\mathrm{WE}}$ can be $\mathrm{V}_{\mathrm{IL}}$ if $\overline{\mathrm{OE}}$ is $\mathrm{V}_{\mathrm{LL}}, \overline{\mathrm{OE}}$ at $\mathrm{V}_{\mathrm{IH}}$ initiates the write operations.
*4: Vcc = $3.3 \mathrm{~V} \pm 10 \%$
*5: It is also used for the extended sector group protection.

Table3 MBM29LV652UE Command Definitions

| Command Sequence | Bus Cycles Req'd | First Bus Write Cycle |  | Second Bus Write Cycle |  | Third Bus Write Cycle |  | Fourth Bus Read/Write Cycle |  | Fifth Bus Write Cycle |  | Sixth Bus Write Cycle |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data | Addr. | Data |
| Read/Reset | 1 | XXXh | FOh | - | - | - | - | - | - | - | - | - | - |
| Read/Reset | 3 | XXXh | AAh | XXXh | 55h | XXXh | FOh | RA | RD | - | - | - | - |
| Autoselect | 3 | XXXh | AAh | XXXh | 55h | XXXh | 90h | - | - | - | - | - | - |
| Program | 4 | XXXh | AAh | XXXh | 55h | XXXh | A0h | PA | PD | - | - | - | - |
| Chip Erase | 6 | XXXh | AAh | XXXh | 55h | XXXh | 80h | XXXh | AAh | XXXh | 55h | XXXh | 10h |
| Sector Erase | 6 | XXXh | AAh | XXXh | 55h | XXXh | 80h | XXXh | AAh | XXXh | 55h | SA | 30h |
| Erase Suspend | 1 | XXXh | B0h | - | - | - | - | - | - | - | - | - | - |
| Erase Resume | 1 | XXXh | 30h | - | - | - | - | - | - | - | - | - | - |
| Set to <br> Fast Mode | 3 | XXXh | AAh | XXXh | 55h | XXXh | 20h | - | - | - | - | - | - |
| Fast <br> Program *1 | 2 | XXXh | A0h | PA | PD | - | - | - | - | - | - | - | - |
| Reset from Fast Mode *1 | 2 | XXXh | 90h | XXXh | FOh | - | - | - | - | - | - | - | - |
| Extended Sector Group Protection *2 | 4 | XXXh | 60h | SPA | 60h | SPA | 40h | SPA | SD | - | - | - | - |
| Query *3 | 1 | XXh | 98h | - | - | - | - | - | - | - | - | - | - |
| Hi-ROM Entry | 3 | XXXh | AAh | XXXh | 55h | XXXh | 88h | - | - | - | - | - | - |
| Hi-ROM Program *4 | 4 | XXXh | AAh | XXXh | 55h | XXXh | A0h | PA | PD | - | - | - | - |
| $\begin{array}{\|l} \hline \mathrm{Hi-ROM} \\ \text { Exit *4 } \\ \hline \end{array}$ | 4 | XXXh | AAh | XXXh | 55h | XXXh | 90h | XXXh | 00h | - | - | - | - |

## MBM29LV652UE-90/12

*1: This command is valid while Fast Mode.
*2: This command is valid while RESET $=\mathrm{V}_{\mathrm{I}}$.
*3: The valid addresses are $A_{6}$ to $A_{0}$.
*4: This command is valid while Hi -ROM mode.
Notes: 1. Address bits = $\mathrm{X}=$ " H " or " "L" for all address commands except or Program Address (PA) and Sector Address (SA).
2. Bus operations are defined in Table 2.
3. RA = Address of the memory location to be read.

PA = Address of the memory location to be programmed. Addresses are latched on the falling edge of the write pulse.
$S A=$ Address of the sector to be erased. The combination of $\mathrm{A}_{21}, \mathrm{~A}_{20}, \mathrm{~A}_{19}, \mathrm{~A}_{18}, \mathrm{~A}_{17}, \mathrm{~A}_{16}$ and $\mathrm{A}_{15}$ will uniquely select any sector.
4. $\mathrm{RD}=$ Data read from location RA during read operation.

PD = Data to be programmed at location PA. Data is latched on the falling edge of write pulse.
5. $\mathrm{SPA}=$ Sector group address to be protected. Set sector group address $(S G A)$ and $\left(A_{6}, A_{1}, A_{0}\right)=(0,1,0)$.

SD = Sector group protection verify data. Output 01h at protected sector group addresses and output 00h at unprotected sector group addresses.
6. Both Read/Reset commands are functionally equivalent, resetting the device to the read mode.

Table 4.1 MBM29LV652UE Sector Group Protection Verify Autoselect Codes

| Type | $\mathbf{A}_{17}$ to $\mathbf{A}_{21}$ | $\mathbf{A}_{6}$ | $\mathbf{A}_{1}$ | $\mathbf{A}_{0}$ | Code (HEX) |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Manufacturer's Code | X | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IL}}$ | 04 h |
| Device Code | MBM29LV652UE | X | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{H}}$ |
| Sector Group Protection | Sector Group <br> Addresses | $\mathrm{V}_{\mathrm{IL}}$ | $\mathrm{V}_{\mathrm{IH}}$ | $\mathrm{V}_{\mathrm{IL}}$ | 02 D 7 h |

*: Outputs 01 h at protected sector group addresses and outputs 00 h at unprotected sector group addresses.
Table 4.2 Expanded Autoselect Code Table

| Type | Code | $\mathbf{D Q}_{15}$ | $\mathbf{D Q}_{14}$ | $\mathbf{D Q}_{13}$ | $\mathbf{D Q}_{12}$ | $\mathbf{D Q}_{11}$ | $\mathbf{D Q}_{10}$ | $\mathbf{D Q}_{9}$ | $\mathbf{D Q}_{8}$ | $\mathbf{D Q}_{7}$ | $\mathbf{D Q}_{6}$ | $\mathbf{D Q}_{5}$ | $\mathbf{D Q}_{4}$ | $\mathbf{D Q}_{3}$ | $\mathbf{D Q}_{2}$ | $\mathbf{D Q}_{1}$ | $\mathbf{D Q}_{0}$ |
| :--- | ---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Manufacturer's Code <br> Device <br> Code <br> MBM29LV652UE | 22h | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 0 |
| Sector Group Protection | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 1 |  |

## MBM29LV652UE-90/12

- FLEXIBLE SECTOR-ERASE ARCHITECTURE

Table 5 Sector Address Tables

| Sector Address | $\mathrm{A}_{21}$ | $\mathrm{A}_{20}$ | $\mathrm{A}_{19}$ | A18 | A 17 | $\mathrm{A}_{16}$ | $\mathrm{A}_{15}$ | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SAO | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 32 K words | 000000h to 007FFFh |
| SA1 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 32 K words | 008000h to 00FFFFh |
| SA2 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | 32 K words | 010000h to 017FFFh |
| SA3 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | 32 K words | 018000h to 01FFFFh |
| SA4 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | 32 K words | 020000h to 027FFFh |
| SA5 | 0 | 0 | 0 | 0 | 1 | 0 | 1 | 32 K words | 028000h to 02FFFFh |
| SA6 | 0 | 0 | 0 | 0 | 1 | 1 | 0 | 32 K words | 030000h to 037FFFh |
| SA7 | 0 | 0 | 0 | 0 | 1 | 1 | 1 | 32 K words | 038000h to 03FFFFh |
| SA8 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 32 K words | 040000h to 047FFFh |
| SA9 | 0 | 0 | 0 | 1 | 0 | 0 | 1 | 32 K words | 048000h to 04FFFFh |
| SA10 | 0 | 0 | 0 | 1 | 0 | 1 | 0 | 32 K words | 050000h to 057FFFh |
| SA11 | 0 | 0 | 0 | 1 | 0 | 1 | 1 | 32 K words | 058000h to 05FFFFh |
| SA12 | 0 | 0 | 0 | 1 | 1 | 0 | 0 | 32 K words | 060000h to 067FFFh |
| SA13 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | 32 K words | 068000h to 06FFFFh |
| SA14 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | 32 K words | 070000h to 077FFFh |
| SA15 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | 32 K words | 078000h to 07FFFFh |
| SA16 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 32 K words | 080000h to 087FFFh |
| SA17 | 0 | 0 | 1 | 0 | 0 | 0 | 1 | 32 K words | 088000h to 08FFFFh |
| SA18 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | 32 K words | 090000h to 097FFFh |
| SA19 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | 32 K words | 098000h to 09FFFFh |
| SA20 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | 32 K words | 0A0000h to 0A7FFFh |
| SA21 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 32 K words | 0A8000h to 0AFFFFh |
| SA22 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | 32 K words | 0B0000h to 0B7FFFh |
| SA23 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | 32 K words | OB8000h to 0BFFFFh |
| SA24 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | 32 K words | 0C0000h to 0C7FFFh |
| SA25 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | 32 K words | 0C8000h to 0CFFFFh |
| SA26 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | 32 K words | 0D0000h to 0D7FFFh |
| SA27 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 32 K words | 0D8000h to 0DFFFFh |
| SA28 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | 32 K words | 0E0000h to 0E7FFFh |
| SA29 | 0 | 0 | 1 | 1 | 1 | 0 | 1 | 32 K words | 0E8000h to 0EFFFFh |
| SA30 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 32 K words | 0F0000h to 0F7FFFh |
| SA31 | 0 | 0 | 1 | 1 | 1 | 1 | 1 | 32 K words | 0F8000h to 0FFFFFh |

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| Sector Address | $\mathrm{A}_{21}$ | $\mathrm{A}_{20}$ | $\mathrm{A}_{19}$ | A18 | $\mathrm{A}_{17}$ | A16 | A15 | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SA32 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 32 K words | 100000h to 107FFFh |
| SA33 | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 32 K words | 108000h to 10FFFFh |
| SA34 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 32 K words | 110000h to 117FFFh |
| SA35 | 0 | 1 | 0 | 0 | 0 | 1 | 1 | 32 K words | 118000h to 11FFFFh |
| SA36 | 0 | 1 | 0 | 0 | 1 | 0 | 0 | 32 K words | 120000h to 127FFFh |
| SA37 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 32 K words | 128000h to 12FFFFh |
| SA38 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 32 K words | 130000h to 137FFFh |
| SA39 | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 32K words | 138000h to 13FFFFh |
| SA40 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 32 K words | 140000h to 147FFFh |
| SA41 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 32 K words | 148000h to 14FFFFh |
| SA42 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 32 K words | 150000h to 157FFFh |
| SA43 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 32 K words | 158000h to 15FFFFh |
| SA44 | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 32 K words | 160000h to 167FFFh |
| SA45 | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 32 K words | 168000h to 16FFFFh |
| SA46 | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 32 K words | 170000h to 177FFFh |
| SA47 | 0 | 1 | 0 | 1 | 1 | 1 | 1 | 32 K words | 178000h to 17FFFFh |
| SA48 | 0 | 1 | 1 | 0 | 0 | 0 | 0 | 32 K words | 180000h to 187FFFh |
| SA49 | 0 | 1 | 1 | 0 | 0 | 0 | 1 | 32 K words | 188000h to 18FFFFh |
| SA50 | 0 | 1 | 1 | 0 | 0 | 1 | 0 | 32 K words | 190000h to 197FFFh |
| SA51 | 0 | 1 | 1 | 0 | 0 | 1 | 1 | 32 K words | 198000h to 19FFFFh |
| SA52 | 0 | 1 | 1 | 0 | 1 | 0 | 0 | 32 K words | 1A0000h to 1A7FFFh |
| SA53 | 0 | 1 | 1 | 0 | 1 | 0 | 1 | 32 K words | 1A8000h to 1AFFFFh |
| SA54 | 0 | 1 | 1 | 0 | 1 | 1 | 0 | 32 K words | 1B0000h to 1B7FFFh |
| SA55 | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 32 K words | 1B8000h to 1BFFFFh |
| SA56 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 32 K words | 1C0000h to 1C7FFFh |
| SA57 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 32K words | 1C8000h to 1CFFFFh |
| SA58 | 0 | 1 | 1 | 1 | 0 | 1 | 0 | 32 K words | 1D0000h to 1D7FFFh |
| SA59 | 0 | 1 | 1 | 1 | 0 | 1 | 1 | 32K words | 1D8000h to 1DFFFFh |
| SA60 | 0 | 1 | 1 | 1 | 1 | 0 | 0 | 32 K words | 1E0000h to 1E7FFFh |
| SA61 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 32 K words | 1E8000h to 1EFFFFh |
| SA62 | 0 | 1 | 1 | 1 | 1 | 1 | 0 | 32K words | 1F0000h to 1F7FFFh |
| SA63 | 0 | 1 | 1 | 1 | 1 | 1 | 1 | 32 K words | 1F8000h to 1FFFFFh |

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| Sector Address | $\mathrm{A}_{21}$ | $\mathrm{A}_{20}$ | $\mathrm{A}_{19}$ | A18 | $\mathrm{A}_{17}$ | $\mathrm{A}_{16}$ | $\mathrm{A}_{15}$ | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SA64 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 32 K words | 200000h to 207FFFh |
| SA65 | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 32 K words | 208000h to 20FFFFh |
| SA66 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 32 K words | 210000h to 217FFFh |
| SA67 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | 32 K words | 218000h to 21FFFFh |
| SA68 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 32 K words | 220000h to 227FFFh |
| SA69 | 1 | 0 | 0 | 0 | 1 | 0 | 1 | 32 K words | 228000h to 22FFFFh |
| SA70 | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 32 K words | 230000h to 237FFFh |
| SA71 | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 32 K words | 238000h to 23FFFFh |
| SA72 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 32 K words | 240000h to 247FFFh |
| SA73 | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 32 K words | 248000h to 24FFFFh |
| SA74 | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 32 K words | 250000h to 257FFFh |
| SA75 | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 32 K words | 258000h to 25FFFFh |
| SA76 | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 32 K words | 260000h to 267FFFh |
| SA77 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 32 K words | 268000h to 26FFFFh |
| SA78 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 32 K words | 270000h to 277FFFh |
| SA79 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 32 K words | 278000h to 27FFFFh |
| SA80 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 32 K words | 280000h to 287FFFh |
| SA81 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 32 K words | 288000h to 28FFFFh |
| SA82 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 32 K words | 290000h to 297FFFh |
| SA83 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 32 K words | 298000h to 29FFFFh |
| SA84 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 32 K words | 2A0000h to 2A7FFFh |
| SA85 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 32 K words | 2A8000h to 2AFFFFh |
| SA86 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 32 K words | 2B0000h to 2B7FFFh |
| SA87 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | 32 K words | 2B8000h to 2BFFFFh |
| SA88 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | 32 K words | 2C0000h to 2C7FFFh |
| SA89 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 32 K words | 2C8000h to 2CFFFFh |
| SA90 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | 32 K words | 2D0000h to 2D7FFFh |
| SA91 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | 32 K words | 2D8000h to 2DFFFFh |
| SA92 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 32 K words | 2E0000h to 2E7FFFh |
| SA93 | 1 | 0 | 1 | 1 | 1 | 0 | 1 | 32 K words | 2E8000h to 2EFFFFh |
| SA94 | 1 | 0 | 1 | 1 | 1 | 1 | 0 | 32 K words | 2F0000h to 2F7FFFh |
| SA95 | 1 | 0 | 1 | 1 | 1 | 1 | 1 | 32 K words | 2F8000h to 2FFFFFh |

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| Sector Address | $\mathrm{A}_{21}$ | $\mathrm{A}_{20}$ | $\mathrm{A}_{19}$ | A18 | $\mathrm{A}_{17}$ | $\mathrm{A}_{16}$ | $\mathrm{A}_{15}$ | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SA96 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 32 K words | 300000h to 307FFFh |
| SA97 | 1 | 1 | 0 | 0 | 0 | 0 | 1 | 32 K words | 308000h to 30FFFFh |
| SA98 | 1 | 1 | 0 | 0 | 0 | 1 | 0 | 32 K words | 310000h to 317FFFh |
| SA99 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 32 K words | 318000h to 31FFFFh |
| SA100 | 1 | 1 | 0 | 0 | 1 | 0 | 0 | 32 K words | 320000h to 327FFFh |
| SA101 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 32 K words | 328000h to 32FFFFh |
| SA102 | 1 | 1 | 0 | 0 | 1 | 1 | 0 | 32 K words | 330000h to 337FFFh |
| SA103 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 32 K words | 338000h to 33FFFFh |
| SA104 | 1 | 1 | 0 | 1 | 0 | 0 | 0 | 32 K words | 340000h to 347FFFh |
| SA105 | 1 | 1 | 0 | 1 | 0 | 0 | 1 | 32 K words | 348000h to 34FFFFh |
| SA106 | 1 | 1 | 0 | 1 | 0 | 1 | 0 | 32 K words | 350000h to 357FFFh |
| SA107 | 1 | 1 | 0 | 1 | 0 | 1 | 1 | 32 K words | 358000h to 35FFFFh |
| SA108 | 1 | 1 | 0 | 1 | 1 | 0 | 0 | 32 K words | 360000h to 367FFFh |
| SA109 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | 32K words | 368000h to 36FFFFh |
| SA110 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | 32 K words | 370000h to 377FFFh |
| SA111 | 1 | 1 | 0 | 1 | 1 | 1 | 1 | 32 K words | 378000h to 37FFFFh |
| SA112 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 32 K words | 380000h to 387FFFh |
| SA113 | 1 | 1 | 1 | 0 | 0 | 0 | 1 | 32 K words | 388000h to 38FFFFh |
| SA114 | 1 | 1 | 1 | 0 | 0 | 1 | 0 | 32 K words | 390000h to 397FFFh |
| SA115 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 32K words | 398000h to 39FFFFh |
| SA116 | 1 | 1 | 1 | 0 | 1 | 0 | 0 | 32 K words | 3A0000h to 3A7FFFh |
| SA117 | 1 | 1 | 1 | 0 | 1 | 0 | 1 | 32 K words | 3A8000h to 3AFFFFh |
| SA118 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | 32 K words | 3B0000h to 3B7FFFh |
| SA119 | 1 | 1 | 1 | 0 | 1 | 1 | 1 | 32 K words | 3B8000h to 3BFFFFh |
| SA120 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 32 K words | 3C0000h to 3C7FFFh |
| SA121 | 1 | 1 | 1 | 1 | 0 | 0 | 1 | 32K words | 3C8000h to 3CFFFFh |
| SA122 | 1 | 1 | 1 | 1 | 0 | 1 | 0 | 32 K words | 3D0000h to 3D7FFFh |
| SA123 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 32 K words | 3D8000h to 3DFFFFh |
| SA124 | 1 | 1 | 1 | 1 | 1 | 0 | 0 | 32 K words | 3E0000h to 3E7FFFh |
| SA125 | 1 | 1 | 1 | 1 | 1 | 0 | 1 | 32K words | 3E8000h to 3EFFFFh |
| SA126 | 1 | 1 | 1 | 1 | 1 | 1 | 0 | 32 K words | 3F0000h to 3F7FFFh |
| SA127 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 32 K words | 3F8000h to 3FFFFFh |

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Table 6 Sector Group Address

| Sector Group Address | $\mathrm{A}_{21}$ | $\mathrm{A}_{20}$ | $\mathrm{A}_{19}$ | $\mathrm{A}_{18}$ | $\mathrm{A}_{17}$ | Sector Group Size | Sectors |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SGA0 | 0 | 0 | 0 | 0 | 0 | 128K words | SA0 to SA3 |
| SGA1 | 0 | 0 | 0 | 0 | 1 | 128K words | SA4 to SA7 |
| SGA2 | 0 | 0 | 0 | 1 | 0 | 128 K words | SA8 to SA11 |
| SGA3 | 0 | 0 | 0 | 1 | 1 | 128K words | SA12 to SA15 |
| SGA4 | 0 | 0 | 1 | 0 | 0 | 128 K words | SA16 to SA19 |
| SGA5 | 0 | 0 | 1 | 0 | 1 | 128 K words | SA20 to SA23 |
| SGA6 | 0 | 0 | 1 | 1 | 0 | 128K words | SA24 to SA27 |
| SGA7 | 0 | 0 | 1 | 1 | 1 | 128K words | SA28 to SA31 |
| SGA8 | 0 | 1 | 0 | 0 | 0 | 128K words | SA32 to SA35 |
| SGA9 | 0 | 1 | 0 | 0 | 1 | 128 K words | SA36 to SA39 |
| SGA10 | 0 | 1 | 0 | 1 | 0 | 128 K words | SA40 to SA43 |
| SGA11 | 0 | 1 | 0 | 1 | 1 | 128K words | SA44 to SA47 |
| SGA12 | 0 | 1 | 1 | 0 | 0 | 128K words | SA48 to SA51 |
| SGA13 | 0 | 1 | 1 | 0 | 1 | 128K words | SA52 to SA55 |
| SGA14 | 0 | 1 | 1 | 1 | 0 | 128 K words | SA56 to SA59 |
| SGA15 | 0 | 1 | 1 | 1 | 1 | 128 K words | SA60 to SA63 |
| SGA16 | 1 | 0 | 0 | 0 | 0 | 128K words | SA64 to SA67 |
| SGA17 | 1 | 0 | 0 | 0 | 1 | 128K words | SA68 to SA71 |
| SGA18 | 1 | 0 | 0 | 1 | 0 | 128K words | SA72 to SA75 |
| SGA19 | 1 | 0 | 0 | 1 | 1 | 128 K words | SA76 to SA79 |
| SGA20 | 1 | 0 | 1 | 0 | 0 | 128 K words | SA80 to SA83 |
| SGA21 | 1 | 0 | 1 | 0 | 1 | 128K words | SA84 to SA87 |
| SGA22 | 1 | 0 | 1 | 1 | 0 | 128K words | SA88 to SA91 |
| SGA23 | 1 | 0 | 1 | 1 | 1 | 128K words | SA92 to SA95 |
| SGA24 | 1 | 1 | 0 | 0 | 0 | 128K words | SA96 to SA99 |
| SGA25 | 1 | 1 | 0 | 0 | 1 | 128K words | SA100 to SA103 |
| SGA26 | 1 | 1 | 0 | 1 | 0 | 128 K words | SA104 to SA107 |
| SGA27 | 1 | 1 | 0 | 1 | 1 | 128K words | SA108 to SA111 |
| SGA28 | 1 | 1 | 1 | 0 | 0 | 128K words | SA112 to SA115 |
| SGA29 | 1 | 1 | 1 | 0 | 1 | 128K words | SA116 to SA119 |
| SGA30 | 1 | 1 | 1 | 1 | 0 | 128K words | SA120 to SA123 |
| SGA31 | 1 | 1 | 1 | 1 | 1 | 128K words | SA124 to SA127 |

Table 7 Common Flash Memory Interface Code

| Description | $\mathrm{A}_{0}$ to $\mathrm{A}_{6}$ | $\mathrm{DQ}_{0}$ to $\mathrm{DQ}_{15}$ |
| :---: | :---: | :---: |
| Query-unique ASCII string "QRY" | $\begin{aligned} & \hline \text { 10h } \\ & \text { 11h } \\ & \text { 12h } \end{aligned}$ | $\begin{aligned} & \text { 0051h } \\ & 0052 \mathrm{~h} \\ & 0059 \mathrm{~h} \end{aligned}$ |
| Primary OEM Command Set 2h: AMD/FJ standard type | $\begin{aligned} & 13 \mathrm{~h} \\ & 14 \mathrm{~h} \end{aligned}$ | $\begin{aligned} & \text { 0002h } \\ & 0000 \mathrm{~h} \end{aligned}$ |
| Address for Primary Extended Table | $\begin{aligned} & 15 \mathrm{~h} \\ & 16 \mathrm{~h} \end{aligned}$ | $\begin{aligned} & \text { 0040h } \\ & 0000 \mathrm{~h} \end{aligned}$ |
| Alternate OEM Command Set ( $00 \mathrm{~h}=$ not applicable) | $\begin{aligned} & 17 \mathrm{~h} \\ & 18 \mathrm{~h} \end{aligned}$ | $\begin{aligned} & \text { 0000h } \\ & \text { 0000h } \end{aligned}$ |
| Address for Alternate OEM Extended Table | $\begin{aligned} & \text { 19h } \\ & 1 \mathrm{Ah} \end{aligned}$ | $\begin{aligned} & \text { 0000h } \\ & \text { 0000h } \end{aligned}$ |
| Vcc Min. (write/erase) D7-4: volt, D3-0: 100 mvolt | 1Bh | 0027h |
| Vcc Max. (write/erase) D7-4: volt, D3-0: 100 mvolt | 1Ch | 0036h |
| VPP Min. voltage | 1Dh | 0000h |
| Vpp Max. voltage | 1Eh | 0000h |
| Typical timeout per single byte/word write $2^{\mathrm{N}} \mu \mathrm{s}$ | 1Fh | 0004h |
| Typical timeout for Min. size buffer write $2^{N} \mu \mathrm{~s}$ | 20h | 0000h |
| Typical timeout per individual block erase $2^{\mathrm{N}} \mathrm{ms}$ | 21h | 000Ah |
| Typical timeout for full chip erase $2^{\mathrm{N}} \mathrm{ms}$ | 22h | 0000h |
| Max. timeout for byte/word write $2^{N}$ times typical | 23h | 0005h |
| Max. timeout for buffer write $2^{N}$ times typical | 24h | 0000h |
| Max. timeout per individual block erase $2^{N}$ times typical | 25h | 0004h |
| Max. timeout for full chip erase $2^{\mathrm{N}}$ times typical | 26h | 0000h |
| Device Size $=2^{\text {N }}$ byte | 27h | 0017h |
| Flash Device Interface description | $\begin{aligned} & \text { 28h } \\ & 29 \mathrm{~h} \end{aligned}$ | $\begin{aligned} & \text { 0001h } \\ & 0000 \mathrm{~h} \end{aligned}$ |
| Max. number of byte in multi-byte write $=2^{\mathrm{N}}$ | $\begin{aligned} & 2 \mathrm{Ah} \\ & 2 \mathrm{Bh} \end{aligned}$ | $\begin{aligned} & \text { 0000h } \\ & \text { 0000h } \end{aligned}$ |
| Number of Erase Block Regions within device | 2Ch | 0001h |
| Erase Block Region 1 Information | $\begin{aligned} & \text { 2Dh } \\ & 2 E h \\ & 2 F h \\ & 30 \mathrm{~h} \end{aligned}$ | 007Fh 0000h 0000h 0001h |


| Description | $\mathrm{A}_{0}$ to $\mathrm{A}_{6}$ | DQ ${ }_{0}$ to $\mathrm{DQ}_{15}$ |
| :---: | :---: | :---: |
| Erase Block Region 2 Information | 31h | 0000h |
|  | 32h | 0000h |
|  | 33h | 0000h |
|  | 34h | 0000h |
| Query-unique ASCII string "PRI" | 40h | 0050h |
|  | 41h | 0052h |
|  | 42h | 0049h |
| Major version number, ASCII | 43h | 0031h |
| Minor version number, ASCII | 44h | 0031h |
| Address Sensitive Unlock Oh = Required <br> 1h = Not Required | 45h | 0001h |
| Erase Suspend Oh = Not Supported 1h = To Read Only $2 \mathrm{~h}=$ To Read \& Write | 46h | 0002h |
| Sector Protection Oh = Not Supported $X=$ Number of sectors in per group | 47h | 0004h |
| Sector Temporary Unprotection 00h = Not Supported 01h = Supported | 48h | 0001h |
| Sector Protection Algorithm | 49h | 0004h |
| Number of Sector for Bank 2 00h = Not Supported | 4Ah | 0000h |
| Burst Mode Type 00h = Not Supported | 4Bh | 0000h |
| Page Mode Type 00h = Not Supported | 4Ch | 0000h |
| ACC (Acceleration) Supply Minimum 00h = Not Supported, D7-4: volt, D3-0: 100 mvolt | 4Dh | 00B5h |
| ACC (Acceleration) Supply Maximum 00h = Not Supported, D7-4: volt, D3-0: 100 mvolt | 4Eh | 00C5h |

## MBM29LV652UE-90/12

## FUNCTIONAL DESCRIPTION

## Read Mode

The MBM29LV652UE has two control functions which must be satisfied in order to obtain data at the outputs. $\overline{\mathrm{CE}}$ is the power control and should be used for a device selection. $\overline{\mathrm{OE}}$ is the output control and should be used to gate data to the output pins if a device is selected.

Address access time (tacc) is equal to the delay from stable addresses to valid output data. The chip enable access time (tcE) is the delay from stable addresses and stable $\overline{\mathrm{CE}}$ to valid data at the output pins. The output enable access time is the delay from the falling edge of $\overline{O E}$ to valid data at the output pins. (Assuming the addresses have been stable for at least tacc-toe time.) When reading out a data without changing addresses after power-up, it is necessary to input hardware reset or to change CE pin from " H " or " L ".

## Standby Mode

There are two ways to implement the standby mode on the MBM29LV652UE devices, one using both the $\overline{\mathrm{CE}}$ and $\overline{\text { RESET }}$ pins; the other via the $\overline{\text { RESET }}$ pin only.
When using both pins, a CMOS standby mode is achieved with $\overline{\mathrm{CE}}$ and $\overline{\mathrm{RESET}}$ inputs both held at $\mathrm{Vcc} \pm 0.3 \mathrm{~V}$. Under this condition the current consumed is less than $5 \mu \mathrm{~A}$ Max. During Embedded Algorithm operation, V cc active current (Iccz) is required even $\overline{\mathrm{CE}}=$ " H ". The device can be read with standard access time ( tcE ) from either of these standby modes.
When using the $\overline{\operatorname{RESET}}$ pin only, a CMOS standby mode is achieved with $\overline{\mathrm{RESET}}$ input held at V ss $\pm 0.3 \mathrm{~V}$ ( $\overline{\mathrm{CE}}$ $=$ " H " or " " "). Under this condition the current consumed is less than $5 \mu \mathrm{~A}$ Max. Once the RESET pin is taken high, the device requires try of wake up time before outputs are valid for read access.
In the standby mode the outputs are in the high impedance state, independent of the $\overline{\mathrm{OE}}$ input.

## Automatic Sleep Mode

There is a function called automatic sleep mode to restrain power consumption during read-out of MBM29LV652UE data. This mode can be used effectively with an application requesting low power consumption such as handy terminals.
To activate this mode, MBM29LV652UE automatically switch themselves to low power mode when MBM29LV652UE addresses remain stable during access fine of 150 ns . It is not necessary to control $\overline{\mathrm{CE}}, \overline{\mathrm{WE}}$, and $\overline{\mathrm{OE}}$ on the mode. Under the mode, the current consumed is typically $1 \mu \mathrm{~A}$ (CMOS Level).

Since the data are latched during this mode, the data are read-out continuously. If the addresses are changed, the mode is canceled automatically and MBM29LV652UE read-out the data for changed addresses.

## Output Disable

With the $\overline{\mathrm{OE}}$ input at a logic high level $\left(\mathrm{V}_{\boldsymbol{H}}\right)$, output from the devices are disabled. This will cause the output pins to be in a high impedance state.

## Autoselect

The autoselect mode allows the reading out of a binary code from the devices and will identify its manufacturer and type. This mode is intended for use by programming equipment for the purpose of automatically matching the devices to be programmed with its corresponding programming algorithm. The Autoselect command may also be used to check the status of write-protected sectors (see Tables 4.1 and 4.2). This mode is functional over the entire temperature range of the devices.
To activate this mode, the programming equipment must force $\mathrm{V}_{\mathrm{ID}}\left(11.5 \mathrm{~V}\right.$ to 12.5 V ) on address pin $\mathrm{A}_{9}$. Two identifier bytes may then be sequenced from the devices outputs by toggling address $A_{0}$ from $\mathrm{V}_{\boldsymbol{\prime}}$ to $\mathrm{V}_{1 \text { н. }}$. All addresses are DON'T CARES except $\mathrm{A}_{0}, \mathrm{~A}_{1}$, and $\mathrm{A}_{6}$. (See Table 2.)

The manufacturer and device codes may also be read via the command register, for instances when the MBM29LV652UE is erased or programmed in a system without access to high voltage on the As pin. The command sequence is illustrated in Table 3. (Refer to Autoselect Command section.)

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Word $0\left(\mathrm{~A}_{0}=\mathrm{V}_{L}\right)$ represents the manufacturer's code (Fujitsu $\left.=04 \mathrm{~h}\right)$ and word $1\left(\mathrm{~A}_{0}=\mathrm{V}_{1 H}\right)$ represents the device identifier code (MBM29LV652UE = 22D7h). These two words are given in the tables 4.1 to 4.2 . All identifiers for manufactures and device will exhibit odd parity with DQ7 defined as the parity bit. In order to read the proper device codes when executing the autoselect, $\mathrm{A}_{1}$ must be $\mathrm{V}_{\text {IL }}$. (See Tables 4.1 to 4.2.)

In order to determine which sectors are write protected, $\mathrm{A}_{1}$ must be at $\mathrm{V}_{\boldsymbol{H}}$ while running through the sector addresses; if the selected sector is protected, a logical ' 1 ' will be output on $\mathrm{DQ}_{0}$ ( $\mathrm{DQ}_{0}=1$ ).

## Write

Device erasure and programming are accomplished via the command register. The contents of the register serve as inputs to the internal state machine. The state machine outputs dictate the function of the device.
The command register itself does not occupy any addressable memory location. The register is a latch used to store the commands, along with the address and data information needed to execute the command. The command register is written by bringing $\overline{\mathrm{WE}}$ to $\mathrm{V}_{\mathrm{IL}}$, while $\overline{\mathrm{CE}}$ is at $\mathrm{V}_{\mathrm{IL}}$ and $\overline{\mathrm{OE}}$ is at $\mathrm{V}_{\mathrm{H}}$. Addresses are latched on the falling edge of $\overline{W E}$ or $\overline{C E}$, whichever happens later; while data is latched on the rising edge of $\overline{W E}$ or $\overline{C E}$, whichever happens first. Standard microprocessor write timings are used.

Refer to AC Write Characteristics and the Erase/Programming Waveforms for specific timing parameters.

## Sector Group Protection

The MBM29LV652UE features hardware sector group protection. This feature will disable both program and erase operations in any combination of thirty two sector groups of memory. (See Table 6). The sector group protection feature is enabled using programming equipment at the user's site. The device is shipped with all sector groups unprotected.
To activate this mode, the programming equipment must force $V_{I D}$ on address pin $A_{9}$ and control pin $\overline{\mathrm{OE}}$, (suggest $\mathrm{V}_{I D}=11.5 \mathrm{~V}$ ), $\overline{\mathrm{CE}}=\mathrm{V}_{I L}$ and $\mathrm{A}_{0}=\mathrm{A}_{6}=\mathrm{V}_{\mathrm{IL}}, \mathrm{A}_{1}=\mathrm{V}_{1 H}$. The sector group addresses ( $\mathrm{A}_{21}, \mathrm{~A}_{20}, \mathrm{~A}_{19}, \mathrm{~A}_{18}$, and $\mathrm{A}_{17}$ ) should be set to the sector to be protected. Table 5 defines the sector address for each of the one hundred twenty-eight (128) individual sectors, and tables 2 defines the sector group address for each of the thirty-two (32) individual group sectors. Programming of the protection circuitry begins on the falling edge of the WE pulse and is terminated with the rising edge of the same. Sector group addresses must be held constant during the WE pulse. See figures 14 and 22 for sector group protection waveforms and algorithm.

To verify programming of the protection circuitry, the programming equipment must force $\mathrm{V}_{\mathrm{I} \text { o }}$ on address pin $\mathrm{A}_{9}$ with $\overline{\mathrm{CE}}$ and $\overline{\mathrm{OE}}$ at $\mathrm{V}_{\mathrm{I}}$ and $\overline{\mathrm{WE}}$ at $\mathrm{V}_{1 \text { н }}$. Scanning the sector group addresses ( $\mathrm{A}_{21}, \mathrm{~A}_{20}, \mathrm{~A}_{19}, \mathrm{~A}_{18}$, and $\mathrm{A}_{17}$ ) while $\left(A_{6}, A_{1}, A_{0}\right)=(0,1,0)$ will produce a logical "1" code at device output DQ for a protected sector. Otherwise the device will produce " 0 " for unprotected sector. In this mode, the lower order addresses, except for $A_{0}, A_{1}$, and $\mathrm{A}_{6}$ are DON'T CARES. Address locations with $\mathrm{A}_{1}=\mathrm{V}_{\text {IL }}$ are reserved for Autoselect manufacturer and device codes.

It is also possible to determine if a sector group is protected in the system by writing an Autoselect command. Performing a read operation at the address location XX02h, where the higher order addresses (A $\mathrm{A}_{21}, \mathrm{~A}_{20}, \mathrm{~A}_{19}, \mathrm{~A}_{18}$, and $\mathrm{A}_{17}$ ) are the desired sector group address will produce a logical "1" at $\mathrm{DQ}_{0}$ for a protected sector group. See Tables 4.1 and 4.2 for Autoselect codes.

## Temporary Sector Group Unprotection

This feature allows temporary unprotection of previously protected sector groups of the MBM29LV652UE devices in order to change data. The Sector Group Unprotection mode is activated by setting the RESET pin to high voltage ( $\mathrm{V}_{\mathrm{ID}}$ ). During this mode, formerly protected sector groups can be programmed or erased by selecting the sector group addresses. Once the $\mathrm{V}_{10}$ is taken away from the RESET pin, all the previously protected sector groups will be protected again. Refer to Figures 15 and 23.

This temporary sector group unprotect mode is disabled whenever the chip is in the Hidden ROM (Hi-ROM) mode. This area can not be programmed within this mode. Moreover once this area is programmed, it is always protected no matter in which mode.

## RESET

## Hardware Reset Pin

The MBM29LV652UE devices may be reset by driving the $\overline{\text { RESET }}$ pin to VIL. The $\overline{\text { RESET }}$ pin has a pulse requirement and has to be kept low (VI) for at least "trp" in order to properly reset the internal state machine. Any operation in the process of being executed will be terminated and the internal state machine will be reset to the read mode "tready" after the RESET pin is driven low. Furthermore, once the RESET pin goes high, the devices require an additional "trh" before it will allow read access. When the RESET pin is low, the devices will be in the standby mode for the duration of the pulse and all the data output pins will be tri-stated. If a hardware reset occurs during a program or erase operation, the data at that particular location will be corrupted.

## Accelerated Program Operation

MBM29LV652UE offers accelerated program operation which enables the programming in high speed. If the system asserts V $_{\text {Acc }}$ to the ACC pin, the device automatically enters the acceleration mode and the time required for program operation will reduce to about $50 \%$. This function is primarily intended to allow high speed program, so caution is needed as the sector group will temporarily be unprotected.

The system would use a fast program command sequence when programming during acceleration mode. Set command to fast mode and reset command from fast mode is not necessary. When the device enters the acceleration mode, the device automatically set to fast mode. Therefore, the present sequence could be used for programming and detection of completion during acceleration mode.
Removing $V_{A C C}$ from the ACC pin returns the device to normal operation. Do not remove $V_{A C C}$ from the $A C C$ pin while programming. (See Figure 17)

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## - COMMAND DEFINITIONS

Device operations are selected by writing specific address and data sequences into the command register. Writing incorrect data values or writing them in the improper sequence will reset the devices to the read mode. Table 3 defines the valid register command sequences. Note that the Erase Suspend (BOh) and Erase Resume (30h) commands are valid only while the Sector Erase operation is in progress. Moreover both Read/Reset commands are functionally equivalent, resetting the device to the read mode. Please note that commands are always written at $\mathrm{DQ}_{0}$ to $\mathrm{DQ}_{7}$ and $\mathrm{DQ}_{8}$ to $\mathrm{DQ}_{15}$ bits are ignored.

## Read/Reset Command

In order to return from Autoselect mode or Exceeded Timing Limits ( $\mathrm{DQ}_{5}=1$ ) to Read/Reset mode, the Read/ Reset operation is initiated by writing the Read/Reset command sequence into the command register. Microprocessor read cycles retrieve array data from the memory. The devices remain enabled for reads until the command register contents are altered.

The devices will automatically power-up in the Read/Reset state. In this case, a command sequence is not required to read data. Standard microprocessor read cycles will retrieve array data. This default value ensures that no spurious alteration of the memory content occurs during the power transition. Refer to the AC Read Characteristics and Waveforms for the specific timing parameters.

## Autoselect Command

Flash memories are intended for use in applications where the local CPU alters memory contents. As such, manufacture and device codes must be accessible while the devices reside in the target system. PROM programmers typically access the signature codes by raising $A_{9}$ to a high voltage. However, multiplexing high voltage onto the address lines is not generally desired system design practice.

The device contains an Autoselect command operation to supplement traditional PROM programming methodology. The operation is initiated by writing the Autoselect command sequence into the command register.
The Autoselect command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle that contains the address and the Autoselect command. Then the manufacture and device codes can be read from the address, and an actual data of memory cell can be read from the another address.

Following the command write, a read cycle from address XX00h retrieves the manufacture code of 04h. A read cycle from address XX01h returns the device code (MBM29LV652UE = 22D7h).

All manufacturer and device codes will exhibit odd parity with DQ7 defined as the parity bit. Sector state (protection or unprotection) will be informed by address XX02h. Scanning the sector group addresses (A21, $\mathrm{A}_{20}, \mathrm{~A}_{19}, \mathrm{~A}_{18}$, and $A_{17}$ ) while ( $\left.A_{6}, A_{1}, A_{0}\right)=(0,1,0)$ will produce a logical " 1 " at device output $D Q_{0}$ for a protected sector group. The programming verification should be performed by verify sector group protection on the protected sector. (See Table 2.)
To terminate the operation, it is necessary to write the Read/Reset command sequence into the register, and also to write the Autoselect command during the operation, execute it after writing Read/Reset command sequence.

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## Word Programming

The devices are programmed on a word-by-word basis. Programming is a four bus cycle operation. There are two "unlock" write cycles. These are followed by the program set-up command and data write cycles. Addresses are latched on the falling edge of CE or WE, whichever happens later and the data is latched on the rising edge of $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$, whichever happens first. The rising edge of $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$ (whichever happens first) begins programming. Upon executing the Embedded Program Algorithm command sequence, the system is not required to provide further controls or timings. The device will automatically provide adequate internally generated program pulses and verify the programmed cell margin.
The system can determine the status of the program operation by using DQ7 ( $\overline{\text { Data }}$ Polling), and DQ6 (Toggle Bit) or RY/BY. The Data Polling and Toggle Bit must be performed at the memory location which is being programmed.

The automatic programming operation is completed when the data on $\mathrm{DQ}_{7}$ is equivalent to data written to this bit at which time the devices return to the read mode and addresses are no longer latched. (See Table 8, Hardware Sequence Flags.) Therefore, the devices require that a valid address to the devices be supplied by the system at this particular instance of time. Hence, Data Polling must be performed at the memory location which is being programmed.

Any commands written to the chip during this period will be ignored. If hardware reset occurs during the programming operation, it is impossible to guarantee the data are being written.
Programming is allowed in any sequence and across sector boundaries. Beware that a data " 0 " cannot be programmed back to a " 1 " Attempting to do so may either hang up the device or result in an apparent success according to the data polling algorithm but a read from Read/Reset mode will show that the data is still " 0 " Only erase operations can convert " 0 "s to " 1 "s.

Figure 18 illustrates the Embedded Program ${ }^{\text {TM }}$ Algorithm using typical command strings and bus operations.

## Chip Erase

Chip erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the chip erase command.

Chip erase does not require the user to program the device prior to erase. Upon executing the Embedded Erase Algorithm command sequence the devices will automatically program and verify the entire memory for an all zero data pattern prior to electrical erase (Preprogram function). The system is not required to provide any controls or timings during these operations.
The system can determine the status of the erase operation by using DQ7 ( $\overline{\text { Data }}$ Polling), and DQ ${ }_{6}$ (Toggle Bit). The chip erase begins on the rising edge of the last $\overline{C E}$ or $\overline{W E}$, whichever happens first in the command sequence and terminates when the data on DQ7 is " 1 " (See Write Operation Status section.) at which time the device returns to read the mode.

Chip Erase Time; Sector Erase Time $\times$ All sectors + Chip Program Time (Preprogramming)
Figure 19 illustrates the Embedded Erase ${ }^{\text {TM }}$ Algorithm using typical command strings and bus operations.

## Sector Erase

Sector erase is a six bus cycle operation. There are two "unlock" write cycles. These are followed by writing the "set-up" command. Two more "unlock" write cycles are then followed by the Sector Erase command. The sector address (any address location within the desired sector) is latched on the falling edge of $\overline{C E}$ or $\overline{W E}$ whichever happens later, while the command ( $\mathrm{Data}=30 \mathrm{~h}$ ) is latched on the rising edge of $\overline{\mathrm{CE}}$ or WE which happens first. After time-out of "trow" from the rising edge of the last sector erase command, the sector erase operation will begin.

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Multiple sectors may be erased concurrently by writing the six bus cycle operations on Table 3. This sequence is followed with writes of the Sector Erase command to addresses in other sectors desired to be concurrently erased. The time between writes must be less than "tow" otherwise that command will not be accepted and erasure will start. It is recommended that processor interrupts be disabled during this time to guarantee this condition. The interrupts can be re-enabled after the last Sector Erase command is written. A time-out of "trow" from the rising edge of last $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$ whichever happens first will initiate the execution of the Sector Erase command(s). If another falling edge of $\overline{\mathrm{CE}}$ or WE , whichever happens first occurs within the "trow" time-out window the timer is reset. (Monitor $\mathrm{DQ}_{3}$ to determine if the sector erase timer window is still open, see section $\mathrm{DQ}_{3}$, Sector Erase Timer.) Any command other than Sector Erase or Erase Suspend during this time-out period will reset the devices to the read mode, ignoring the previous command string. Resetting the devices once execution has begun will corrupt the data in the sector. In that case, restart the erase on those sectors and allow them to complete. (Refer to the Write Operation Status section for Sector Erase Timer operation.) Loading the sector erase buffer may be done in any sequence and with any number of sectors (0 to 127).

Sector erase does not require the user to program the devices prior to erase. The devices automatically program all memory locations in the sector(s) to be erased prior to electrical erase (Preprogram function). When erasing a sector or sectors the remaining unselected sectors are not affected. The system is not required to provide any controls or timings during these operations.

The system can determine the status of the erase operation by using DQ7 (Data Polling), and DQ6 (Toggle Bit)or RY/BY.

The sector erase begins after the "trow" time out from the rising edge of $\overline{\mathrm{CE}}$ or $\overline{\mathrm{WE}}$ whichever happens first for the last sector erase command pulse and terminates when the data on DQ 7 is " 1 " (See Write Operation Status section.) at which time the devices return to the read mode. Data polling and Toggle Bit must be performed at an address within any of the sectors being erased.

Multiple Sector Erase Time; [Sector Erase Time + Sector Program Time (Preprogramming)] $\times$ Number of Sector Erase

Figure 19 illustrates the Embedded Erase ${ }^{\text {TM }}$ Algorithm using typical command strings and bus operations.

## Erase Suspend/Resume

The Erase Suspend command allows the user to interrupt a Sector Erase operation and then perform data reads from or programs to a sector not being erased. This command is applicable ONLY during the Sector Erase operation which includes the time-out period for sector erase. The Erase Suspend command will be ignored if written during the Chip Erase operation or Embedded Program Algorithm. Writting the Erase Suspend command (BOh) during the Sector Erase time-out results in immediate termination of the time-out period and suspension of the erase operation.

Writing the Erase Resume command (30h) resumes the erase operation. The addresses are "Don't Care" when writting the Erase Suspend or Erase Resume command.
When the Erase Suspend command is written during the Sector Erase operation, the device will take a maximum of "tspo" to suspend the erase operation. When the devices have entered the erase-suspended mode, the RY/ $\overline{\mathrm{BY}}$ output pin will be at $\mathrm{Hi}-\mathrm{z}$ and the $\mathrm{DQ}_{7}$ bit will be at logic " 1 " and $\mathrm{DQ}_{6}$ will stop toggling. The user must use the address of the erasing sector for reading $\mathrm{DQ}_{6}$ and $\mathrm{DQ}_{7}$ to determine if the erase operation has been suspended. Further writes of the Erase Suspend command are ignored.

When the erase operation has been suspended, the devices default to the erase-suspend-read mode. Reading data in this mode is the same as reading from the standard read mode except that the data must be read from sectors that have not been erase-suspended. Successively reading from the erase-suspended sector while the device is in the erase-suspend-read mode will cause $\mathrm{DQ}_{2}$ to toggle. (See the section on $\mathrm{DQ}_{2}$.)

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After entering the erase-suspend-read mode, the user can program the device by writing the appropriate command sequence for Program. This program mode is known as the erase-suspend-program mode. Again, programming in this mode is the same as programming in the regular Program mode except that the data must be programmed to sectors that are not erase-suspended. Successively reading from the erase-suspended sector while the devices are in the erase-suspend-program mode will cause $\mathrm{DQ}_{2}$ to toggle. The end of the erasesuspended Program operation is detected by the RY/ $\overline{\mathrm{BY}}$ output pin, Data polling of $\overline{\mathrm{DQ}}_{7}$ or by the Toggle Bit I $\left(D Q_{6}\right)$ which is the same as the regular Program operation. Note that $D Q_{7}$ must be read from the Program address while $\mathrm{DQ}_{6}$ can be read from any address.
To resume the operation of Sector Erase, the Resume command (30h) should be written. Any further writes of the Resume command at this point will be ignored. Another Erase Suspend command can be written after the chip has resumed erasing.

## Extended Command

(1) Fast Mode

MBM29LV652UE has Fast Mode function. This mode dispenses with the initial two unclock cycles required in the standard program command sequence by writing Fast Mode command into the command register. In this mode, the required bus cycle for programming is two cycles instead of four bus cycles in standard program command. (Do not write erase command in this mode.) The read operation is also executed after exiting this mode. To exit this mode, it is necessary to write Fast Mode Reset command into the command register. (Refer to the Figure 24.) The Vcc active current is required even $\overline{\mathrm{CE}}=\mathrm{V}_{\boldsymbol{\prime}}$ during Fast Mode.
(2) Fast Programming

During Fast Mode, the programming can be executed with two bus cycles operation. The Embedded Program Algorithm is executed by writing program set-up command (AOh) and data write cycles (PA/PD). (Refer to the Figure 24.)

## (3) Extended Sector Group Protection

In addition to normal sector group protection, the MBM29LV652UE has Extended Sector Group Protection as extended function. This function enable to protect sector group by forcing Vio on RESET pin and write a command sequence. Unlike conventional procedure, it is not necessary to force $\mathrm{V}_{10}$ and control timing for control pins. The only RESET pin requires ViD for sector group protection in this mode. The extended sector group protection requires VID on RESET pin. With this condition, the operation is initiated by writing the set-up command ( 60 h ) into the command register. Then, the sector group addresses pins ( $\mathrm{A}_{21}, \mathrm{~A}_{20}, \mathrm{~A}_{19}, \mathrm{~A}_{18}$, and $\mathrm{A}_{17}$ ) and ( $\mathrm{A}_{6}, \mathrm{~A}_{1}, \mathrm{~A}_{0}$ ) $=$ $(0,1,0)$ should be set to the sector group to be protected (recommend to set $\mathrm{V}_{\mathrm{I}}$ for the other addresses pins), and write extended sector group protection command (60h). A sector group is typically protected in $250 \mu \mathrm{~s}$. To verify programming of the protection circuitry, the sector group addresses pins ( $A_{21}, A_{20}, A_{19}, A_{18}$, and $A_{17}$ ) and ( $\left.A_{6}, A_{1}, A_{0}\right)=(0,1,0)$ should be set and write a command (40h). Following the command write, a logical " 1 " at device output DQo will produce for protected sector in the read operation. If the output data is logical " 0 ", please repeat to write extended sector group protection command ( 60 h ) again. To terminate the operation, it is necessary to set RESET pin to $\mathrm{V}_{\text {Iн. }}$ (Refer to the Figures 16 and 25.)
(4) CFI (Common Flash Memory Interface)

The CFI (Common Flash Memory Interface) specification outlines device and host system software interrogation handshake which allows specific vendor-specified software algorithms to be used for entire families of devices. This allows device-independent, JEDEC ID-independent, and forward-and backward-compatible software support for the specified flash device families. Refer to CFI specification in detail.
The operation is initiated by writing the query command (98h) into the command register. Following the command write, a read cycle from specific address retrieves device information. Please note that output data of upper byte (DQ8 to DQ15) is " 0 " in word mode (16 bit) read. Refer to the CFI code table. To terminate operation, it is necessary to write the read/reset command sequence into the register. (See Table 7.)

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## Hidden ROM (Hi-ROM) Region

The Hi-ROM feature provides a Flash memory region that the system may access through a new command sequence. This is primarily intended for customers who wish to use an Electronic Serial Number (ESN) in the device with the ESN protected against modification. Once the Hi-ROM region is programmed, any further modification of that region is impossible. This ensures the security of the ESN once the product is shipped to the field.

The Hi-ROM region is 128 words in length. After the system has written the Enter Hi-ROM command sequence, it may read the Hidden ROM region by using device addresses $A_{0}$ to $A_{6}$ ( $A_{7}$ to $A_{14}$ are " 00 ", $A_{15}$ to $A_{21}$ are don't care). That is, the device sends only program command that would normally be sent to the address to the Hi ROM region. This mode of operation continues until the system issues the Exit Hi-ROM command sequence, or until power is removed from the device. On power-up, or following a hardware reset, the device reverts to sending commands to the address.

## Hidden ROM (Hi-ROM) Entry Command

MBM29LV652UE has a Hidden ROM area with One Time Protect function. This area is to enter the security code and to unable the change of the code once set. Program is possible in this area until it is protected. However, once it is protected, it is impossible to unprotect, so please use this with caution.

Hidden ROM area is 128 words in length. Write the Hidden ROM entry command sequence to enter the Hidden ROM area. It is called as Hidden ROM mode when the Hidden ROM area appears. After the system has written the Enter Hi -ROM command sequence, it may read the Hidden ROM region by using device addresses $\mathrm{A}_{0}$ to $\mathrm{A}_{6}$ ( $\mathrm{A}_{7}$ to $\mathrm{A}_{14}$ are " 00 ", $\mathrm{A}_{15}$ to $\mathrm{A}_{21}$ are don't care).
Read/program of the Hidden ROM area is possible during Hidden ROM mode. Write the Hidden ROM reset command sequence to exit the Hidden ROM mode.

## Hidden ROM (Hi-ROM) Program Command

To program the data to the Hidden ROM area, write the Hidden ROM program command sequence during Hidden ROM mode. This command is same as the program command in the past except to write the command during Hidden ROM mode. Therefore the detection of completion method is the same as in the past, using the DQ7 data poling, $\mathrm{DQ}_{6}$ toggle bit and RY/BY pin.

## Hidden ROM (Hi-ROM) Protect Command

There are two methods to protect the Hidden ROM area. One is to write the sector group protect setup command $(60 \mathrm{~h})$, set the sector address to select $\left(\mathrm{A}_{6}, \mathrm{~A}_{1}, \mathrm{~A}_{0}\right)=(0,1,0)$ and Hidden ROM area and write the sector group protect command(60h) during the Hidden ROM mode. Same command sequence could be used because other then the Hidden ROM mode and that is does not apply high voltage to RESET pin, it is same as the extension sector group protect in the past. Please refer "Function Explanation Extended Command (3) Extentended Sector Group Protection" for details of extention sector group protect setting.

The other is to apply high voltage $\left(V_{I D}\right)$ to A 9 and $\overline{\mathrm{OE}}$, specify the sector address to select ( $\left.\mathrm{A}_{6}, \mathrm{~A}_{1}, \mathrm{~A}_{0}\right)=(0,1,0)$ and Hidden ROM area, and apply the write pulse during the Hidden ROM mode. To verify the protect circuit, apply high voltage ( $\mathrm{V}_{\mathrm{I}}$ ) to A 9 , specify $\left(\mathrm{A}_{6}, \mathrm{~A}_{1}, \mathrm{~A}_{0}\right)=(0,1,0)$ and the sector address to select the Hidden ROM area, and read. When " 1 " appears to $D Q_{0}$, the protect setting is completed. " 0 " will appear to $\mathrm{DQ}_{0}$ if it is not protected. Please apply write pulse agian. Same command sequence could be used for the above method because other then the Hidden ROM mode, it is same as the sector group protect in the past. Please refer "Function Explanation Secor Group Protection" for details of sector group protect setting

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Once it is protected, protection can not be cancelled, so please pay closest attention.

## Write Operation Status

Detailed in Table 8 are all the status flags that can be used to check the status of the device for current mode operation. During sector erase, the part provides the status flags automatically to the I/O ports. The information on $\mathrm{DQ}_{2}$ is address sensitive. This means that if an address from an erasing sector is consecutively read, then the $\mathrm{DQ}_{2}$ bit will toggle. However, $\mathrm{DQ}_{2}$ will not toggle if an address from a non-erasing sector is consecutively read. This allows the user to determine which sectors are erasing and which are not.
Once erase suspend is entered, address sensitivity still applies. If the address of a non-erasing sector (that is, one available for read) is provided, then stored data can be read from the device. If the address of an erasing sector (that is, one unavailable for read) is applied, the device will output its status bits.

Table 8 Hardware Sequence Flags

| Status |  |  | DQ ${ }_{7}$ | DQ6 | DQ5 | DQ ${ }^{\text {a }}$ | DQ2 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| In Progress | Embedded Program Algorithm |  | $\overline{\mathrm{DQ}}_{7}$ | Toggle | 0 | 0 | 1 |
|  | Embedded Erase Algorithm |  | 0 | Toggle | 0 | 1 | Toggle* |
|  | Erase <br> Suspended <br> Mode | Erase Suspend Read (Erase Suspended Sector) | 1 | 1 | 0 | 0 | Toggle |
|  |  | Erase Suspend Read (Non-Erase Suspended Sector) | Data | Data | Data | Data | Data |
|  |  | Erase Suspend Program (Non-Erase Suspended Sector) | $\overline{\mathrm{DQ}}{ }_{7}$ | Toggle | 0 | 0 | 1* |
| Exceeded Time Limits | Embedded Program Algorithm |  | ${\overline{\mathrm{DQ}}{ }_{7}}$ | Toggle | 1 | 0 | 1 |
|  | Embedded Erase Algorithm |  | 0 | Toggle | 1 | 1 | N/A |
|  | Erase <br> Suspended <br> Mode | Erase Suspend Program <br> (Non-Erase Suspended Sector) | $\overline{\mathrm{DQ}}{ }_{7}$ | Toggle | 1 | 0 | N/A |

*: Successive reads from the erasing or erase-suspend sector will cause $\mathrm{DQ}_{2}$ to toggle. Reading from non-erase suspend sector address will indicate logic " 1 " at the DQ2 bit.

Notes: 1. DQ ${ }_{0}$ and $\mathrm{DQ}_{1}$ are reserve pins for future use.
2. $\mathrm{DQ}_{4}$ is Fujitsu internal use only.

DQ7

## Data Polling

The MBM29LV652UE devices feature Data Polling as a method to indicate to the host that the Embedded Algorithms are in progress or completed. During the Embedded Program Algorithm an attempt to read the devices will produce the complement of the data last written to DQ7. Upon completion of the Embedded Program Algorithm, an attempt to read the device will produce the true data last written to DQ7. During the Embedded Erase Algorithm, an attempt to read the device will produce a " 0 " at the DQ7 output. Upon completion of the Embedded Erase Algorithm an attempt to read the device will produce a " 1 " at the DQ7 output. The flowchart for Data Polling (DQ7) is shown in Figure 20.

For programming, the Data Polling is valid after the rising edge of fourth write pulse in the four write pulse sequence.

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For chip erase and sector erase, the $\overline{\text { Data }}$ Polling is valid after the rising edge of the sixth write pulse in the six write pulse sequence. Data Polling must be performed at sector address within any of the sectors being erased and not a protected sector. Otherwise, the status may not be valid.

Once the Embedded Algorithm operation is close to being completed, the MBM29LV652UE data pins (DQ7) may change asynchronously while the output enable $(\overline{\mathrm{OE}})$ is asserted low. This means that the devices are driving status information on $\mathrm{DQ}_{7}$ at one instant of time and then that byte's valid data at the next instant of time. Depending on when the system samples the $\mathrm{DQ}_{7}$ output, it may read the status or valid data. Even if the device has completed the Embedded Algorithm operation and DQ7 has a valid data, the data outputs on DQo to DQ6 may be still invalid. The valid data on $\mathrm{DQ}_{0}$ to $\mathrm{DQ}_{7}$ will be read on the successive read attempts.
The Data Polling feature is only active during the Embedded Programming Algorithm, Embedded Erase Algorithm or sector erase time-out. (See Table 8.)

See Figure 9 for the Data Polling timing specifications and diagram.

## DQ6

## Toggle Bit I

The MBM29LV652UE also feature the "Toggle Bit l" as a method to indicate to the host system that the Embedded Algorithms are in progress or completed.

During an Embedded Program or Erase Algorithm cycle, successive attempts to read ( $\overline{\mathrm{OE}}$ toggling) data from the devices will result in DQ6 toggling between one and zero. Once the Embedded Program or Erase Algorithm cycle is completed, DQ6 will stop toggling and valid data will be read on the next successive attempts. During programming, the Toggle Bit I is valid after the rising edge of the fourth write pulse in the four write pulse sequence. For chip erase and sector erase, the Toggle Bit I is valid after the rising edge of the sixth write pulse in the six write pulse sequence. The Toggle Bit I is active during the sector time out.

In programming, if the sector being written to is protected, the toggle bit will toggle for about $1 \mu \mathrm{~s}$ and then stop toggling without the data having changed. In erase, the devices will erase all the selected sectors except for the ones that are protected. If all selected sectors are protected, the chip will toggle the toggle bit for about $400 \mu \mathrm{~s}$ and then drop back into read mode, having changed none of the data.

Either $\overline{\mathrm{CE}}$ or $\overline{\mathrm{OE}}$ toggling will cause the $\mathrm{DQ}_{6}$ to toggle. In addition, an Erase Suspend/Resume command will cause the DQ6 to toggle.

See Figure 10 for the Toggle Bit I timing specifications and diagram.

## DQ5

## Exceeded Timing Limits

DQ5 will indicate if the program or erase time has exceeded the specified limits (internal pulse count). Under these conditions DQ5 will produce a " 1 ". This is a failure condition which indicates that the program or erase cycle was not successfully completed. Data Polling is the only operating function of the devices under this condition. The $\overline{\mathrm{CE}}$ circuit will partially power down the device under these conditions (to approximately 2 mA ). The $\overline{\mathrm{OE}}$ and $\overline{\mathrm{WE}}$ pins will control the output disable functions as described in Table 2.

The DQs failure condition may also appear if a user tries to program a non blank location without erasing. In this case the devices lock out and never complete the Embedded Algorithm operation. Hence, the system never reads a valid data on DQ7 bit and $\mathrm{DQ}_{6}$ never stops toggling. Once the devices have exceeded timing limits, the DQ5 bit will indicate a " 1 ". Please note that this is not a device failure condition since the devices were incorrectly used. If this occurs, reset the device with command sequence.

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## DQ3

## Sector Erase Timer

After the completion of the initial sector erase command sequence the sector erase time-out will begin. $\mathrm{DQ}_{3}$ will remain low until the time-out is complete. Data Polling and Toggle Bit are valid after the initial sector erase command sequence.
If Data Polling or the Toggle Bit I indicates the device has been written with a valid erase command, DQ3 may be used to determine if the sector erase timer window is still open. If $\mathrm{DQ}_{3}$ is high ("1") the internally controlled erase cycle has begun; attempts to write subsequent commands to the device will be ignored until the erase operation is completed as indicated by Data Polling or Toggle Bit I. If $\mathrm{DQ}_{3}$ is low ("0"), the device will accept additional sector erase commands. To insure the command has been accepted, the system software should check the status of $\mathrm{DQ}_{3}$ prior to and following each subsequent Sector Erase command. If $\mathrm{DQ}_{3}$ were high on the second status check, the command may not have been accepted.

See Table 8 : Hardware Sequence Flags.

## DQ2

## Toggle Bit II

This toggle bit II, along with $\mathrm{DQ}_{6}$, can be used to determine whether the devices are in the Embedded Erase Algorithm or in Erase Suspend.
Successive reads from the erasing sector will cause $\mathrm{DQ}_{2}$ to toggle during the Embedded Erase Algorithm. If the devices are in the erase-suspended-read mode, successive reads from the erase-suspended sector will cause $\mathrm{DQ}_{2}$ to toggle. When the devices are in the erase-suspended-program mode, successive reads from the byte address of the non-erase suspended sector will indicate a logic "1" at the $\mathrm{DQ}_{2}$ bit.
$D Q_{6}$ is different from $\mathrm{DQ}_{2}$ in that $\mathrm{DQ}_{6}$ toggles only when the standard program or Erase, or Erase Suspend Program operation is in progress. The behavior of these two status bits, along with that of $\mathrm{DQ}_{7}$, is summarized as follows:

For example, $\mathrm{DQ}_{2}$ and $\mathrm{DQ}_{6}$ can be used together to determine if the erase-suspend-read mode is in progress. (DQ2 toggles while DQ6 does not.) See also Table 9 and Figure 11.

Furthermore, $\mathrm{DQ}_{2}$ can also be used to determine which sector is being erased. When the device is in the erase mode, $\mathrm{DQ}_{2}$ toggles if this bit is read from an erasing sector.

Table 9 Toggle Bit Status

| Mode | DQQ $_{7}$ | DQQ $_{6}$ | DQ $_{\mathbf{2}}$ |
| :--- | :---: | :---: | :---: |
| Program | $\overline{\mathrm{DQ}}_{7}$ | Toggle | 1 |
| Erase | 0 | Toggle | Toggle * |
| Erase-Suspend Read <br> (Erase-Suspended Sector) | 1 | 1 | Toggle |
| Erase-Suspend Program | $\overline{\mathrm{DQ}}_{7}$ | Toggle | $1^{*}$ |

*: Successive reads from the erasing or erase-suspend sector will cause $\mathrm{DQ}_{2}$ to toggle. Reading from non-erase suspend sector address will indicate logic "1" at the DQ2 bit.

## RY/ $\overline{B Y}$

## Ready/Busy

The MBM29LV652UE provide a RY/ $\overline{\mathrm{BY}}$ open-drain output pin as a way to indicate to the host system that the Embedded Algorithms are either in progress or has been completed. If the output is low, the devices are busy with either a program or erase operation. If the output is high, the devices are ready to accept any read/write or erase operation. When the RY/BY pin is low, the devices will not accept any additional program or erase commands. If the MBM29LV652UE is placed in an Erase Suspend mode, the RY/BY output will be high.
During programming, the $\mathrm{RY} / \overline{\mathrm{BY}}$ pin is driven low after the rising edge of the fourth write pulse. During an erase operation, the $\mathrm{RY} / \overline{\mathrm{BY}}$ pin is driven low after the rising edge of the sixth write pulse. The $\mathrm{RY} / \overline{\mathrm{BY}}$ pin will indicate a busy condition during the $\overline{\text { RESET }}$ pulse. Refer to Figures 12 and 13 for a detailed timing diagram. The RY/ $\overline{\mathrm{BY}}$ pin is pulled high in standby mode.
Since this is an open-drain output, RY/BY pins can be tied together in parallel with a pull-up resistor to Vcc.

## Data Protection

The MBM29LV652UE is designed to offer protection against accidental erasure or programming caused by spurious system level signals that may exist during power transitions. During power up the devices automatically reset the internal state machine in the Read mode. Also, with its control register architecture, alteration of the memory contents only occurs after successful completion of specific multi-bus cycle command sequences. The devices also incorporate several features to prevent inadvertent write cycles resulting form Vcc power-up and power-down transitions or system noise.

## Low Vcc Write Inhibit

To avoid initiation of a write cycle during $\mathrm{V}_{\mathrm{cc}}$ power-up and power-down, a write cycle is locked out for Vcc less than $\mathrm{V}_{\text {кко }}(\mathrm{min})$. If $\mathrm{V}_{\mathrm{cc}}<\mathrm{V}_{\text {Lко, }}$, the command register is disabled and all internal program/erase circuits are disabled. Under this condition the device will reset to the read mode. Subsequent writes will be ignored until the Vcc level is greater than VLko. It is the users responsibility to ensure that the control pins are logically correct to prevent unintentional writes when $\mathrm{V}_{\mathrm{cc}}$ is above $\mathrm{V}_{\mathrm{Lko}}$ (Min.).

If Embedded Erase Algorithm is interrupted, there is possibility that the erasing sector(s) cannot be used.

## Write Pulse "Glitch" Protection

Noise pulses of less than 3 ns (typical) on $\overline{\mathrm{OE}}, \overline{\mathrm{CE}}$, or $\overline{\mathrm{WE}}$ will not initiate a write cycle.

## Logical Inhibit

Writing is inhibited by holding any one of $\overline{\mathrm{OE}}=\mathrm{V}_{\llcorner }, \overline{\mathrm{CE}}=\mathrm{V}_{\boldsymbol{I}}$, or $\overline{\mathrm{WE}}=\mathrm{V}_{\boldsymbol{\prime}}$. To initiate a write, $\overline{\mathrm{CE}}$ and $\overline{\mathrm{WE}}$ must be a logical zero while $\overline{\mathrm{OE}}$ is a logical one.

## Power-up Write Inhibit

Power-up of the devices with $\overline{\mathrm{WE}}=\overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}}$ and $\overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}$ will not accept commands on the rising edge of $\overline{\mathrm{WE}}$. The internal state machine is automatically reset to read mode on power-up.

## ABSOLUTE MAXIMUM RATINGS

| Parameter | Symbol | Rating |  | Unit |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Max. |  |
| Storage Temperature | Tstg | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |
| Ambient Temperature with Power Applied | TA | -40 | +85 ${ }^{\circ}$ | ${ }^{\circ} \mathrm{C}$ |
| Voltage with Respect to Ground All Pins Except $\mathrm{A}_{9}, \overline{\mathrm{OE}, ~ A C C ~ a n d ~ R E S E T ~(N o t e ~ 1) ~}$ | Vin, Vout | -0.5 | $\mathrm{Vcc}+0.5$ | V |
| Power Supply Voltage (Note 1) | Vcc | -0.5 | +4.0 | V |
| Aя, $\overline{\mathrm{OE}}, \mathrm{ACC}$, and $\overline{\mathrm{RESET}}$ (Note 2) | Vin | -0.5 | +13.0 | V |
| Power Supply Voltage | V cca | -0.2 | +7.0 | V |

Notes: 1. Minimum DC voltage on input or I/O pins is -0.5 V . During voltage transitions, input or I/O pins may undershoot V ss to -2.0 V for periods of up to 20 ns . Maximum DC voltage on input or I/O pins is V cc +0.5 V . During voltage transitions, input or I/O pins may overshoot to $\mathrm{Vcc}+2.0 \mathrm{~V}$ for periods of up to 20 ns .
2. Minimum DC input voltage on $\mathrm{A}_{9}, \overline{\mathrm{OE}}, \mathrm{ACC}$ and $\overline{\mathrm{RESET}}$ pins is -0.5 V . During voltage transitions, $\mathrm{A}_{9}$, $\overline{\mathrm{OE}}, \mathrm{ACC}$, and $\overline{\mathrm{RESET}}$ pins may undershoot V ss to -2.0 V for periods of up to 20 ns . Voltage difference between input and supply voltage ( $\mathrm{V}_{\mathbb{N}}-\mathrm{V}_{\mathrm{Cc}}$ ) does not exceed 9.0 V . Maximum DC input voltage on $\mathrm{A}_{9}$, $\overline{\mathrm{OE}}, \mathrm{ACC}$, and $\overline{\text { RESET pins }}$ is +13.0 V which may overshoot to +14.0 V for periods of up to 20 ns .

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

## ■ RECOMMENDED OPERATING CONDITIONS

| Parameter |  | Symbol | Value |  | Unit |
| :--- | :--- | :---: | :---: | :---: | :---: |
|  |  |  | Max. |  |  |
| Ambient Temperature | $(-90 /-12)$ | $\mathrm{T}_{\mathrm{A}}$ | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| Power Supply Voltage <br> (Vcc) | $(-90)$ | Vcc | +3.0 | +3.6 | V |
|  | $(-12)$ |  | +3.6 | V |  |
| Power Supply Voltage <br> (Vccq) | $(-90 /-12)$ | $\mathrm{V}_{\mathrm{ccq}}$ | +2.7 | +3.6 | V |

Note: Operating ranges define those limits between which the functionality of the device is guaranteed.
WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.
Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.
No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

## MAXIMUM OVERSHOOT/UNDERSHOOT



Figure 1 Maximum Undershoot Waveform


Figure 2 Maximum Overshoot Waveform 1


Note: This waveform is applied for $\mathrm{A} 9, \overline{\mathrm{OE}}, \mathrm{ACC}$, and $\overline{\mathrm{RESET}}$.

Figure 3 Maximum Overshoot Waveform 2

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## ELECTRICAL CHARACTERISTICS

## 1. DC Characteristics

| Parameter Symbol | Parameter Description | Test Conditions | Min. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| IL | Input Leakage Current | $\begin{aligned} & V_{\mathbb{N}}=V_{s s} \text { to } V_{c c,}, V_{c c}=V_{c c} \text { Max., } \\ & V_{c c q}=V_{c c q} \text { Max. } \end{aligned}$ | -1.0 | +1.0 | $\mu \mathrm{A}$ |
| ILo | Output Leakage Current | $\begin{aligned} & V_{\text {out }}=V_{s s} \text { to } V_{c c}, V_{c c}=V_{c c} \text { Max., } \\ & V_{c c q}=V_{c c q} \text { Max. } \end{aligned}$ | -1.0 | +1.0 | $\mu \mathrm{A}$ |
| Іıт | $\mathrm{A}_{9}, \overline{\mathrm{OE}}, \overline{\mathrm{RESET}}$ Inputs Leakage Current | $\begin{aligned} & V_{c c}=V_{c c} \text { Max., } \\ & A_{9}, \overline{O E}, \text { RESET }=12.5 \mathrm{~V} \end{aligned}$ | - | 35 | $\mu \mathrm{A}$ |
| IAcc | ACC Accelerated Program Current | $\begin{aligned} & V_{C C}=V_{C C} \text { Max., } \\ & A C C=V_{A C C} \text { Max. } \end{aligned}$ | - | 20 | mA |
| Icc1 | Vcc Active Current (Note 1) | $\begin{aligned} & \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{LL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}, \mathrm{~V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Max} ., \\ & \mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Max} ., \mathrm{f}=5 \mathrm{MHz} \end{aligned}$ | - | 16 | mA |
|  |  | $\begin{aligned} & \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{LL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}, \mathrm{~V} \mathrm{Vc}=\mathrm{V}_{c \mathrm{c}} \mathrm{Max} ., \\ & \mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Max} ., \mathrm{f}=1 \mathrm{MHz} \end{aligned}$ | - | 7 | mA |
| Icca | Vcc Active Current (Note 2) | $\begin{aligned} & \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{LL}}, \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{H}}, \mathrm{~V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Max} ., \\ & \mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Max} . \end{aligned}$ | - | 40 | mA |
| Iccз | Vcc Current (Standby) | $\begin{aligned} & \mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \operatorname{Max.} ., \mathrm{V} c \mathrm{q}=\mathrm{V} c \mathrm{q} \text { Max., } \\ & \mathrm{CE}=\mathrm{V}_{\mathrm{cc}} \pm 0.3 \mathrm{~V}, \\ & \mathrm{RESET}=\mathrm{V} c \mathrm{D} \pm 0.3 \mathrm{~V} \end{aligned}$ | - | 5 | $\mu \mathrm{A}$ |
| Icc4 | Vcc Current (Standby, $\overline{\text { RESET }}$ ) |  | - | 5 | $\mu \mathrm{A}$ |
| Icc5 | Vcc Current <br> (Automatic Sleep Mode) (Note 3) | $\begin{aligned} & \mathrm{V}_{\mathrm{cc}}=\mathrm{V} \mathrm{Vc} \operatorname{Max} ., \mathrm{V} c \mathrm{cq}=\mathrm{V} c \mathrm{cq} \text { Max., } \\ & \mathrm{CE}=\mathrm{Vss} \pm 0.3 \mathrm{~V}, \\ & R E S E T=V c c \pm 0.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{IN}}=\mathrm{V} c \mathrm{~V} \pm 0.3 \mathrm{~V} \text { or } \mathrm{Vss} \pm 0.3 \mathrm{~V} \end{aligned}$ | - | 5 | $\mu \mathrm{A}$ |
| VIL | Input Low Level | - | -0.5 | 0.6 | V |
| $\mathrm{V}_{\mathrm{H}}$ | Input High Level | - | 2.0 | $\mathrm{V} \mathrm{cc}+0.5$ | V |
| $V_{\text {AcC }}$ | Voltage for Program Acceleration | - | 11.5 | 12.5 | V |
| VIo | Voltage for Autoselect, Sector Protection (A9, OE, RESET) (Note 4) | - | 11.5 | 12.5 | V |
| VoL | Output Low Voltage Level | $\begin{aligned} & \mathrm{loL}=4.0 \mathrm{~mA}, \mathrm{~V}_{c \mathrm{c}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Min} ., \\ & \mathrm{V}_{\mathrm{cc}}=\mathrm{V} \mathrm{ccq} \text { Min. } \end{aligned}$ | - | 0.45 | V |
| Vor1 | Output High Voltage Level | $\text { Іон }=-2.0 \mathrm{~mA}, \mathrm{~V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{Min} .,$ $V_{c c q}=V_{c c q}$ Min. | 2.4 | - | V |
| Vон2 |  | $\begin{aligned} & \text { loн }=-100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{cc}} \text { Min., } \\ & \mathrm{V}_{\mathrm{cc}}=\mathrm{V}_{\mathrm{cc}} \mathrm{M} \text { Min. } \end{aligned}$ | $\begin{gathered} \text { Vccq- } \\ 0.4 \end{gathered}$ | - | V |
| Vıko | Low Vcc Lock-Out Voltage | - | 2.3 | 2.5 | V |

Notes: 1. The Icc current listed includes both the DC operating current and the frequency dependent component.
2. Icc active while Embedded Erase or Embedded Program is in progress.
3. Automatic sleep mode enables the low power mode when address remain stable for 150 ns .
4. Applicable for only Vcc applying.

## 2. AC Characteristics

- Read Only Operations Characteristics

| Parameter Symbols |  | Description | Test Setup |  | $\begin{gathered} 90 \\ \text { (Note) } \end{gathered}$ | $\begin{gathered} 12 \\ \text { (Note) } \end{gathered}$ | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  |  |  |  |  |
| tavav | trc | Read Cycle Time | - | Min. | 90 | 120 | ns |
| tavav | tacc | Address to Output Delay | $\begin{aligned} & \overline{\mathrm{CE}}=\mathrm{V}_{\mathrm{IL}} \\ & \overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{IL}} \end{aligned}$ | Max. | 90 | 120 | ns |
| telov | tce | Chip Enable to Output Delay | $\overline{\mathrm{OE}}=\mathrm{V}_{\mathrm{LL}}$ | Max. | 90 | 120 | ns |
| tglav | toe | Output Enable to Output Delay | - | Max. | 35 | 50 | ns |
| tehaz | tof | Chip Enable to Output HIGH-Z | - | Max. | 30 | 30 | ns |
| tahaz | tof | Output Enable to Output HIGH-Z | - | Max. | 30 | 30 | ns |
| taxax | toн | Output Hold Time From Address, CE or OE, Whichever Occurs First | - | Min. | 0 | 0 | ns |
| - | tready | RESET Pin Low to Read Mode | - | Max. | 20 | 20 | $\mu \mathrm{s}$ |

Note: Test Conditions:
Output Load: 1 TTL gate and 30 pF (MBM29LV652UE-90)
1 TTL gate and 100 pF (MBM29LV652UE-12)
Input rise and fall times: 5 ns
Input pulse levels: 0.0 V to 3.0 V
Timing measurement reference level
Input: 1.5 V
Output: 1.5 V


Figure 4 Test Conditions

## MBM29LV652UE-90/12

- Write (Erase/Program) Operations

| Parameter Symbols |  | Description |  |  | 90 | 12 | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  |  |  |  |  |
| tavav | twc | Write Cycle Time |  | Min. | 90 | 120 | ns |
| tavwl | $\mathrm{tas}^{\text {a }}$ | Address Setup Time |  | Min. | 0 | 0 | ns |
| twlax | $\mathrm{taH}^{\text {a }}$ | Address Hold Time |  | Min. | 45 | 50 | ns |
| tovwh | tos | Data Setup Time |  | Min. | 35 | 50 | ns |
| twhox | toh | Data Hold Time |  | Min. | 0 | 0 | ns |
| - | toes | Output Enable Setup Time |  | Min. | 0 | 0 | ns |
| - | toen | Output Enable Hold Time | Read | Min. | 0 | 0 | ns |
|  |  |  | Toggle and Data Polling | Min. | 10 | 10 | ns |
| tghwL | tghwi | Read Recover Time Before Write |  | Min. | 0 | 0 | ns |
| tGHEL | tghel | Read Recover Time Before Write |  | Min. | 0 | 0 | ns |
| telw | tcs | $\overline{\text { CE Setup Time }}$ |  | Min. | 0 | 0 | ns |
| twlel | tws | $\overline{\text { WE Setup Time }}$ |  | Min. | 0 | 0 | ns |
| twher | tch | $\overline{\text { CE }}$ Hold Time |  | Min. | 0 | 0 | ns |
| terwh | twh | $\overline{\text { WE Hold Time }}$ |  | Min. | 0 | 0 | ns |
| twLwh | twp | Write Pulse Width |  | Min. | 35 | 50 | ns |
| teleh | tcp | $\overline{\text { CE Pulse Width }}$ |  | Min. | 35 | 50 | ns |
| twhwL | twph | Write Pulse Width High |  | Min. | 30 | 30 | ns |
| tehel | tcph | $\overline{\text { CE Pulse Width High }}$ |  | Min. | 30 | 30 | ns |
| twhwh 1 | twhwH1 | Word Programming Operation |  | Typ. | 16 | 16 | $\mu \mathrm{s}$ |
| twhwH2 | twhwH2 | Sector Erase Operation (Note 1) |  | Typ. | 1 | 1 | s |
| - | tvcs | Vcc Setup Time |  | Min. | 50 | 50 | $\mu \mathrm{s}$ |
| - | tvidr | Rise Time to $\mathrm{V}_{\text {ID }}$ (Note 2) |  | Min. | 500 | 500 | ns |
| - | tvaccr | Rise Time to $\mathrm{V}_{\text {Acc }}$ (Note 3) |  | Min. | 500 | 500 | ns |
| - | tvLht | Voltage Transition Time (Note 2) |  | Min. | 4 | 4 | $\mu \mathrm{s}$ |
| - | twpp | Write Pulse Width (Note 2) |  | Min. | 100 | 100 | $\mu \mathrm{s}$ |
| - | toEsP | $\overline{\text { OE Setup Time to } \overline{\text { WE }} \text { Active (Note 2) }}$ |  | Min. | 4 | 4 | $\mu \mathrm{s}$ |
| - | tcsp | $\overline{\mathrm{CE}}$ Setup Time to $\overline{\mathrm{WE}}$ Active (Note 2) |  | Min. | 4 | 4 | $\mu \mathrm{s}$ |
| - | $t_{\text {Rb }}$ | Recover Time From RY/ $\overline{\mathrm{BY}}$ |  | Min. | 0 | 0 | ns |
| - | trp | $\overline{\text { RESET Pulse Width }}$ |  | Min. | 500 | 500 | ns |

(Continued)
(Continued)

| Parameter Symbols |  | Description |  | 90 | 12 | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  |  |  |  |
| - | trH | RESET Hold Time Before Read | Min. | 200 | 200 | ns |
| - | trosy | Program/Erase Valid to RY/ $\overline{\mathrm{BY}}$ Delay | Max. | 90 | 90 | ns |
| - | teoe | Delay Time from Embedded Output Enable | Max. | 90 | 120 | ns |
| - | trow | Erase Time-out Time | Min. | 50 | 50 | $\mu \mathrm{s}$ |
| - | tspD | Erase Suspend Transition Time | Max. | 20 | 20 | $\mu \mathrm{s}$ |

Notes: 1. This does not include the preprogramming time.
2. This timing is for Sector Group Protection operation.
3. This timing is for Accelerated Program operation.

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## ■ ERASE AND PROGRAMMING PERFORMANCE

| Parameter | Limits |  |  | Unit | Comments |
| :--- | :---: | :---: | :---: | :---: | :--- |
|  | Min. | Typ. | Max. |  | s |
| Sector Erase Time | - | 1 | 10 | Excludes programming time <br> prior to erasure |  |
| Programming Time | - | 16 | 360 | $\mu \mathrm{~s}$ | Excludes system-level <br> overhead |
| Chip Programming Time | - | - | 200 | s | Excludes system-level <br> overhead |
| Erase/Program Cycle | 100,000 | - | - | cycle | - |

■ PIN CAPACITANCE

| Parameter <br> Symbol | Parameter Description | Test Setup | Typ. | Max. | Unit |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{C}_{\mathbb{N}}$ | Input Capacitance | $\mathrm{V}_{\mathbb{N}=0}$ | 6 | 7.5 | pF |
| $\mathrm{Cout}^{\text {O }}$ | Output Capacitance | $\mathrm{V}_{\mathrm{OUT}}=0$ | 8.5 | 12 | pF |
| $\mathrm{C}_{\mathbb{N} 2}$ | Control Pin Capacitance | $\mathrm{V}_{\mathbb{N}}=0$ | 8 | 10 | pF |
| $\mathrm{C}_{\mathbb{N} 3}$ | ACC Pin Capacitance | $\mathrm{V}_{\mathbb{N}=0}$ | 15 | 20 | pF |

Note: Test conditions $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}=1.0 \mathrm{MHz}$

## - TIMING DIAGRAM

- Key to Switching Waveforms

| WAVEFORM | INPUTS | OUTPUTS |
| :---: | :---: | :---: |
|  | Must Be Steady | Will Be Steady |
| $415$ | May Change from H to L | Will Be Changing from H to L |
| $1 / 1$ | May Change from L to H | Will Be Changing from L to H |
|  | " H " or "L" <br> Any Change Permitted | Changing State Unknown |
|  | Does Not Apply | Center Line is HighImpedance "Off" State |



Figure 5.1 Read Operation Timing Diagram

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Figure 5.2 Hardware Reset/Read Operation Timing Diagram


Notes: 1. PA is address of the memory location to be programmed.
2. PD is data to be programmed at byte address.
3. $\overline{\mathrm{DQ}}_{7}$ is the output of the complement of the data written to the device.
4. Dout is the output of the data written to the device.
5. Figure indicates last two bus cycles out of four bus cycle sequence.

Figure 6 Alternate $\overline{\text { WE }}$ Controlled Program Operation Timing Diagram

## MBM29LV652UE-90/12



Notes: 1. PA is address of the memory location to be programmed.
2. PD is data to be programmed at byte address.
3. $\overline{\mathrm{DQ}}_{7}$ is the output of the complement of the data written to the device.
4. Dout is the output of the data written to the device.
5. Figure indicates last two bus cycles out of four bus cycle sequence.

Figure 7 Alternate $\overline{\text { CE }}$ Controlled Program Operation Timing Diagram

*: SA is the sector address for Sector Erase. Addresses = XXXh for Chip Erase.

Figure 8 Chip/Sector Erase Operation Timing Diagram

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*: DQ7 = Valid Data (The device has completed the Embedded operation.)
Figure 9 Data Polling during Embedded Algorithm Operation Timing Diagram

*: DQ6 = Stops toggling. (The device has completed the Embedded operation.)
Figure 10 Toggle Bit I during Embedded Algorithm Operation Timing Diagram


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## MBM29LV652UE-90/12



SGAX: Sector Group Address to be protected
SGAY : Next Sector Group Address to be protected
TIME-OUT : Time-Out window $=250 \mu \mathrm{~s}$ (Min.)
Figure 16 Extended Sector Group Protection Timing Diagram


Figure 17 Accelerated Program Timing Diagram

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## FLOW CHART

## EMBEDDED ALGORITHMS



Program Command Sequence (Address/Command):


Program Address/Program Data

Figure 18 Embedded Program ${ }^{\text {TM }}$ Algorithm

## EMBEDDED ALGORITHMS



Chip Erase Command Sequence (Address/Command):

Individual Sector/Multiple Sector Erase Command Sequence (Address/Command):


Figure 19 Embedded Erase ${ }^{\text {TM }}$ Algorithm

## MBM29LV652UE-90/12



VA = Byte address for programming = Any of the sector addresses within the sector being erased during sector erase or multiple sector erases operation
= Any of the sector addresses within the sector not being protected during chip erase

Note: $\mathrm{DQ}_{7}$ is rechecked even if $\mathrm{DQ}_{5}=$ " 1 " because $\mathrm{DQ}_{7}$ may change simultaneously with $\mathrm{DQ}_{5}$.

Figure 20 Data Polling Algorithm

*1: Reset toggle bit twice to determine whether or not it is toggle.
*2: Recheck toggle bit because it may stop toggle as DQ5 changes to "1".

Figure 21 Toggle Bit Algorithm


Figure 22 Sector Group Protection Algorithm

*1: All protected sector groups are unprotected.
*2: All previously protected sector groups are protected once again.

Figure 23 Temporary Sector Group Unprotection Algorithm


Figure 24 Extended Sector Group Protection Algorithm

## FAST MODE ALGORITHM



Figure 25 Embedded Program ${ }^{\text {TM }}$ Algorithm for Fast Mode

## MBM29LV652UE-90/12

## ORDERING INFORMATION

## Standard Products

Fujitsu standard products are available in several packages. The order number is formed by a combination of:


## MBM29LV652UE-90/12

## PACKAGE DIMENSIONS

63-pin plastic FBGA (I) (BGA-63P-M02)


## FUJITSU LIMITED

## For further information please contact:

## Japan

FUJITSU LIMITED
Corporate Global Business Support Division Electronic Devices
Shinjuku Dai-Ichi Seimei Bldg. 7-1, Nishishinjuku 2-chome, Shinjuku-ku, Tokyo 163-0721, Japan
Tel: +81-3-5322-3347
Fax: +81-3-5322-3386
http://edevice.fujitsu.com/
North and South America
FUJITSU MICROELECTRONICS, INC. 3545 North First Street, San Jose, CA 95134-1804, U.S.A.
Tel: +1-408-922-9000
Fax: +1-408-922-9179
Customer Response Center
Mon. - Fri.: 7 am- 5 pm (PST)
Tel: +1-800-866-8608
Fax: +1-408-922-9179
http://www.fujitsumicro.com/

## Europe

FUJITSU MICROELECTRONICS EUROPE GmbH Am Siebenstein 6-10,
D-63303 Dreieich-Buchschlag, Germany
Tel: +49-6103-690-0
Fax: +49-6103-690-122
http://www.fujitsu-fme.com/
Asia Pacific
FUJITSU MICROELECTRONICS ASIA PTE. LTD. \#05-08, 151 Lorong Chuan,
New Tech Park,
Singapore 556741
Tel: +65-281-0770
Fax: +65-281-0220
http://www.fmap.com.sg/

## Korea

FUJITSU MICROELECTRONICS KOREA LTD. 1702 KOSMO TOWER, 1002 Daechi-Dong, Kangnam-Gu,Seoul 135-280

## Korea

Tel: +82-2-3484-7100
Fax: +82-2-3484-7111

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[^0]:    *:Peripheral balls on each corner are shorted together via the substrate but not connected to the die.

